

NCE N-Channel Enhancement Mode Power MOSFET

Description

The NCE6050KA uses advanced trench technology and design to provide excellent $R_{DS(ON)}$ with low gate charge. It can be used in a wide variety of applications.

General Features

V_{DS} =60V,I_D =50A

 $R_{DS(ON)}$ <13.8m Ω @ V_{GS} =10V

 $R_{DS(ON)}$ <19.2m Ω @ V_{GS} =4.5V

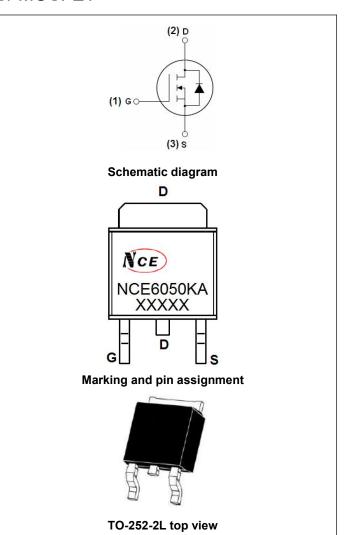
- High density cell design for ultra low Rdson
- Fully characterized avalanche voltage and current
- Good stability and uniformity with high E_{AS}
- Excellent package for good heat dissipation
- Special process technology for high ESD capability

Application

- Power switching application
- Hard switched and high frequency circuits
- Uninterruptible power supply

100% UIS TESTED!

100% ΔVds TESTED!



Package Marking and Ordering Information

| Device Marking | Device | Device Package | Reel Size | Tape width | Quantity |
|----------------|-----------|----------------|-----------|------------|----------|
| NCE6050KA | NCE6050KA | TO-252-2L | - | - | - |

Absolute Maximum Ratings (T_C=25℃unless otherwise noted)

| Parameter | Symbol | Limit | Unit |
|--|-----------------------|------------|------------|
| Drain-Source Voltage | VDS | 60 | V |
| Gate-Source Voltage | Vgs | ±20 | V |
| Drain Current-Continuous | I _D | 50 | А |
| Drain Current-Continuous(T _C =100°ℂ) | I _D (100℃) | 35.4 | Α |
| Pulsed Drain Current | I _{DM} | 200 | Α |
| Maximum Power Dissipation | P _D | 85 | W |
| Derating factor | | 0.57 | W/℃ |
| Single pulse avalanche energy (Note 5) | E _{AS} | 200 | mJ |
| Operating Junction and Storage Temperature Range | T_{J}, T_{STG} | -55 To 175 | $^{\circ}$ |

NCE6050KA

Thermal Characteristic

| Thermal Resistance, Junction-to-Case ^(Note 2) | Rejc | 1.8 | °C/W |] |
|--|------|-----|------|---|
|--|------|-----|------|---|

Electrical Characteristics (T_C=25 ℃ unless otherwise noted)

| Parameter | Symbol | Condition | Min | Тур | Max | Unit |
|------------------------------------|---------------------|---|--------------|------------|------------|---------|
| Off Characteristics | | | | | | |
| Drain-Source Breakdown Voltage | BV _{DSS} | V _{GS} =0V I _D =250μA | 60 | - | - | V |
| Zero Gate Voltage Drain Current | I _{DSS} | V _{DS} =60V,V _{GS} =0V | - | - | 1 | μΑ |
| Gate-Body Leakage Current | I _{GSS} | V _{GS} =±20V,V _{DS} =0V | - | - | ±100 | nA |
| On Characteristics (Note 3) | | | | | | |
| Gate Threshold Voltage | V _{GS(th)} | $V_{DS}=V_{GS},I_{D}=250\mu A$ | 1.15 | 1.6 | 2.5 | V |
| Davis Course On Otata Basistana | _ | V _{GS} =10V, I _D =20A | - | 12 | 13.8 | mΩ |
| Drain-Source On-State Resistance | R _{DS(ON)} | V _{GS} =4.5V, I _D =20A | - | 16 | 19.2 | mΩ |
| Forward Transconductance | g FS | V _{DS} =5V,I _D =20A | 18 | - | - | S |
| Dynamic Characteristics (Note4) | | | | | | |
| Input Capacitance | C _{lss} | \/ 00\/\/ 0\/ | - | 1630 | - | PF |
| Output Capacitance | Coss | V_{DS} =30V, V_{GS} =0V, | - | 113 | - | PF |
| Reverse Transfer Capacitance | Crss | F=1.0MHz | - | 97 | - | PF |
| Switching Characteristics (Note 4) | | | | | | |
| Turn-on Delay Time | t _{d(on)} | | - | 7.4 | - | nS |
| Turn-on Rise Time | t _r | V_{DD} =30V, R _L =6.7 Ω V_{GS} =10V,R _G =3 Ω | - | 5.1 | - | nS |
| Turn-Off Delay Time | $t_{\sf d(off)}$ | | - | 28.2 | - | nS |
| Turn-Off Fall Time | t _f | | - | 5.5 | - | nS |
| Total Gate Charge | Qg | \/ 00\/ L 00A | - | 39 | | nC |
| Gate-Source Charge | Q _{gs} | V _{DS} =30V,I _D =20A, | - | 7 | | nC |
| Gate-Drain Charge | Q_{gd} | V _{GS} =10V | - | 8.5 | | nC |
| Drain-Source Diode Characteristics | | | | | | |
| Diode Forward Voltage (Note 3) | V _{SD} | V _{GS} =0V,I _S =20A | - | - | 1.2 | V |
| Diode Forward Current (Note 2) | Is | | - | - | 50 | Α |
| Reverse Recovery Time | t _{rr} | TJ = 25°C, IF =20A | - | 28 | - | nS |
| Reverse Recovery Charge | Qrr | $di/dt = 100A/\mu s^{(Note3)}$ | - | 40 | - | nC |
| Forward Turn-On Time | t _{on} | Intrinsic turn-on time is negl | igible (turi | n-on is do | ominated b | y LS+LD |

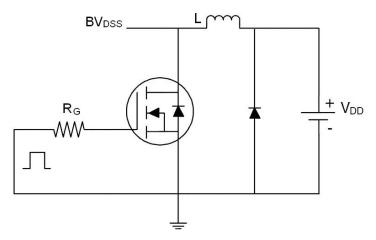
Notes:

- **1.** Repetitive Rating: Pulse width limited by maximum junction temperature.
- 2. Surface Mounted on FR4 Board, t ≤ 10 sec.
- **3.** Pulse Test: Pulse Width $\leq 300 \mu s$, Duty Cycle $\leq 2\%$.
- 4. Guaranteed by design, not subject to production
- **5.** EAS condition : Tj=25 $^{\circ}$ C,V_{DD}=30V,V_G=10V,L=0.5mH,Rg=25 Ω

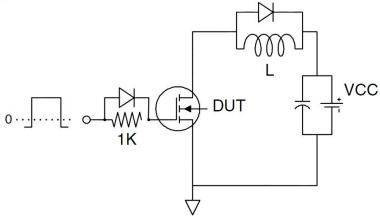


Test Circuit

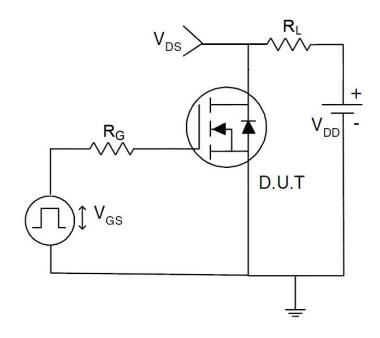
1) E_{AS} test Circuit



2) Gate charge test Circuit



3) Switch Time Test Circuit







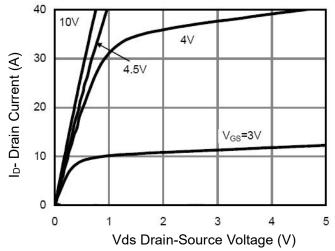


Figure 1 Output Characteristics

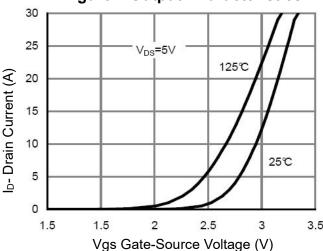


Figure 2 Transfer Characteristics

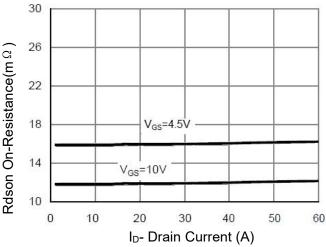


Figure 3 Rdson- Drain Current

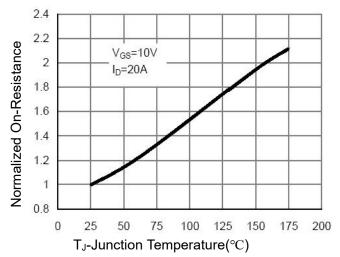
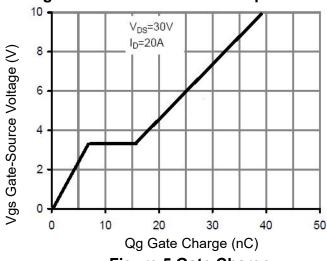


Figure 4 Rdson-Junction Temperature



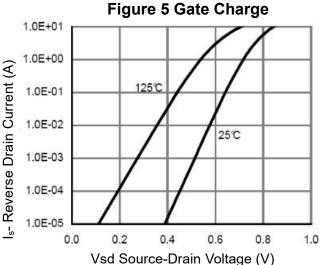


Figure 6 Source- Drain Diode Forward



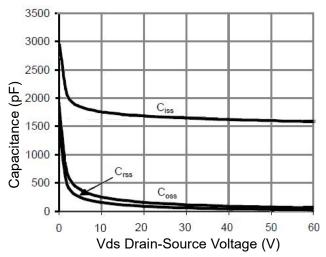


Figure 7 Capacitance vs Vds

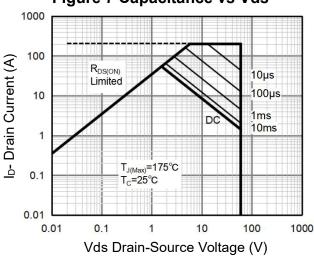


Figure 8 Safe Operation Area(Note 3)

100

80

40

20

0 25 50 75 100 125 150 175

T_C-Case Temperature(°C)

Power Dissipation (W)

Figure 9 Power De-rating

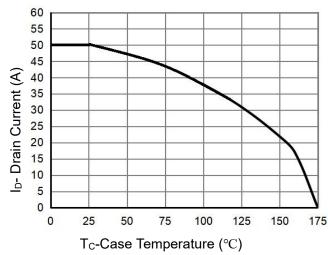


Figure 10 Current De-rating

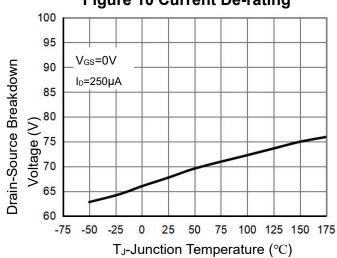


Figure 11 BV_{DSS}-Junction Temperature

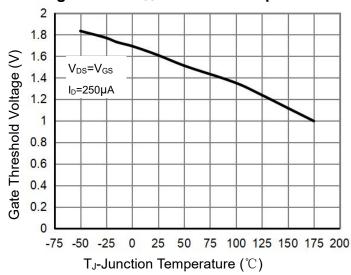


Figure 12 V_{GS(th)}-Junction Temperature



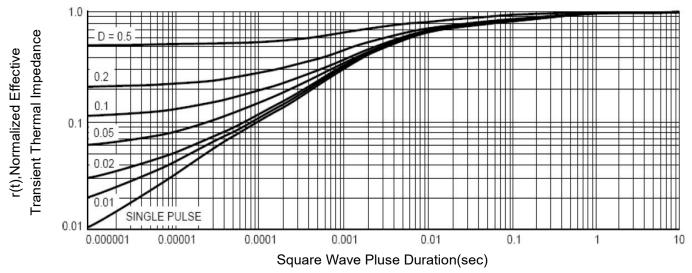
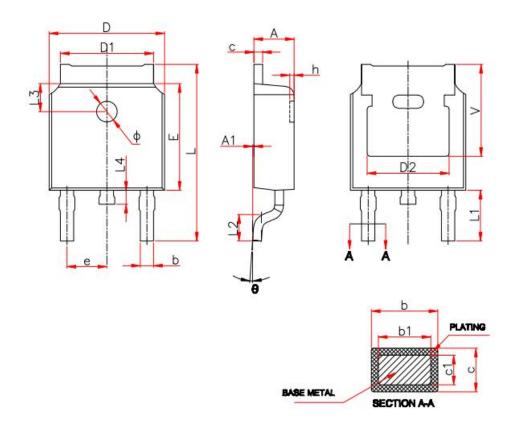


Figure 13 Normalized Maximum Transient Thermal Impedance



TO-252 Package Information



| Cumbal | Millimeters | | | |
|----------|-------------|-------|--|--|
| Symbol - | Min. | Max. | | |
| Α | 2.20 | 2.40 | | |
| A1 | 0.00 | 0.13 | | |
| b | 0.66 | 0.86 | | |
| b1 | 0.73 | 0.79 | | |
| С | 0.46 | 0.58 | | |
| c1 | 0.50 | 0.52 | | |
| D | 6.50 | 6.70 | | |
| D1 | 5.10 5.4 | | | |
| D2 | 4.83 REF. | | | |
| Е | 6.00 | 6.20 | | |
| е | 2.19 | 2.39 | | |
| L | 9.80 | 10.40 | | |
| L1 | 2.90 REF. | | | |
| L2 | 1.40 | 1.70 | | |
| L3 | 1.60 REF. | | | |
| L4 | 0.60 | 1.00 | | |
| Φ | 1.10 | 1.30 | | |
| θ | 0° | 8° | | |





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